# **Ankit More**

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RESEARCH

Digital, Analog and Mixed Signal Integrated Circuits, Radio Frequency Integrated Circuits (RFIC),

INTERESTS Low Power VLSI Circuits, 3-D ICs and Post-CMOS Interconnects.

# EDUCATION $\diamond$ **Ph.D.**, **Electrical Engineering**, (September 2009 – current).

Drexel University, Philadelphia, PA.

Topic: Wireless interconnects for inter and intra-chip communication

♦ M.S., Electrical Engineering, GPA: 3.95 (Summa-cum-laude), (June 2009).

Drexel University, Philadelphia, PA. Concentration: Systems and Control

♦ **B.S., Electrical Engineering**, GPA: 3.95 (Summa-cum-laude), (June 2009).

Drexel University, Philadelphia, PA. Concentration: Advanced Electronics

### PROFESSIONAL & Research Assistant and Teaching Assistant, (September 2009 – current)

#### EXPERIENCE

Department of Electrical and Computer Engineering

Drexel University, Philadelphia, PA

- Research Assistant in the VLSI Lab working on
  - VLSI design and
  - -3D electro-magnetic modeling.
- Teaching Assistant in the ECE Department for
  - Electrical Engineering Laboratory 3 (ECE-L 303) (Fall, AY 2009 2010).
  - Electrical Engineering Laboratory 4 (ECE-L 304) (Winter, AY 2009 2010).

# ♦ Internship - Research and Development Engineering, (April 2008 – September 2008)

Siemens Energy and Automation, Spring House, PA, USA

- Developed automated software testing tools for distributed control systems software.
- Co-authored patent application for an expandable automated testing concept, awaiting filing of application.
- Assisted in Virtual Machine management using VMWare.

#### ♦ Internship - Assistant Project Manager, (September 2006 – March 2007)

Maida Engineering Inc, Fort Washington, PA, USA

- Assisted in design of power distribution systems to manufacturing plants.
- Created two dimensional CAD layouts using AutoCAD for electrical systems according to the NEC.

### SELECTED ♦ Wireless Interconnect Design, Drexel University

#### **PROJECTS**

- Design of on-chip antennas for inter and intra-chip communication for planar and 3D ICs.
- IC design in IBM 90 nm technology.
- Full-wave 3D Finite Element Method (FEM) electro-magnetic simulations.
- Simulation of leakage current, electro-magnetic compatibility and interference.

#### ⋄ Rotary Clock Custom Integrated Circuit, Drexel University

- Design of custom and regular rotary rings.
- IC design in AMI C5N 0.5  $\mu$ m process using MOSIS fabrication process.

# ♦ Senior Design, Unmanned Aerial Vehicle (UAV), Drexel University

- Autonomous control for stable hover of miniature unmanned aerial vehicles.
- Designed a control system using embedded C code on Texas Instruments TMS320 DSP.
- Designed custom peripheral circuits for DSP isolation and sensor connection.
- Co-sponsored by the U.S. Army Research Lab and the MEM Department, Drexel University.

- PUBLICATIONS & Ankit More and Baris Taskin, Electromagnetic Interaction of On-Chip Antennas and CMOS Metal Layers for Wireless IC Interconnects, IEEE/ACM Great Lakes Symposium on VLSI (GLSVLSI), May 2010 (in review).
  - Ankit More and Baris Taskin, Leakage Current Analysis for Intra-Chip Wireless Interconnects, Proceedings of the IEEE International Symposium on Quality Electronic Design (ISQED), March 2010.
  - SKILLS & C, C++, Basic Java, CLisp, XML, XSLT, JScript, VBScript
    - ♦ Cadence Virtuoso Suite, Spectre, PSpice Synopsys - Design Compiler, ICC Complier, HSpice
    - ♦ Ansoft High Frequency Structure Simulator (HFSS), Q3D extractor Agilent – Advanced Design Systems (ADS)
    - Matlab, Maple, Labview, AutoCAD, Quick Test Professional
    - ♦ LATEX, Office Suites
    - ♦ Unix, Linux, MS Windows

# HONORS AND

ACADEMIC  $\diamond$  Graduated with 1<sup>st</sup> Honors (highest GPA among the graduating class) from the Department of Electrical and Computer Engineering, Drexel University, 2009.

AWARDS

- ♦ Dean's List, College of Engineering, Drexel University, 2005 2009.
- ♦ A.J. Drexel Academic Scholarship, Drexel University, 2005 2009.
- ♦ John Raymond Vollmar Endowed Scholarship, Drexel University, 2007 2008.
- ♦ Harry E. Muchnic Scholarship, Drexel University, 2008 2009.
- ♦ Tau Beta Pi National Scholarship, 2008 2009.
- ♦ Member, Tau Beta Pi, Engineering Honor Society.
- Member, Eta Kappa Nu, Electrical Engineering Honor Society.

# Coursework

RELEVANT & CMOS VLSI Design, Computer Architecture, CAD for VLSI Design, Digital IC Design, Stochastic Systems, Microwave Passive Systems, Microwave Active Systems, RF Electronics, Numerical Analysis Methods.

#### REFERENCES ⋄ Dr. Moshe Kam

Department Head and Robert Quinn Professor Department of Electrical and Computer Engineering Drexel University, Philadelphia, PA

E-mail: kam@minerva.ece.drexel.edu

# ♦ Dr. B.C. Chang

Professor, Department of Mechanical Engineering and Mechanines Drexel University, Philadelphia, PA

E-mail: bchang@coe.drexel.edu

#### ⋄ Dr. Baris Taskin

Assistant Professor, Department of Electrical and Computer Engineering Drexel University, Philadelphia, PA

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